

Mechatronic Actuators

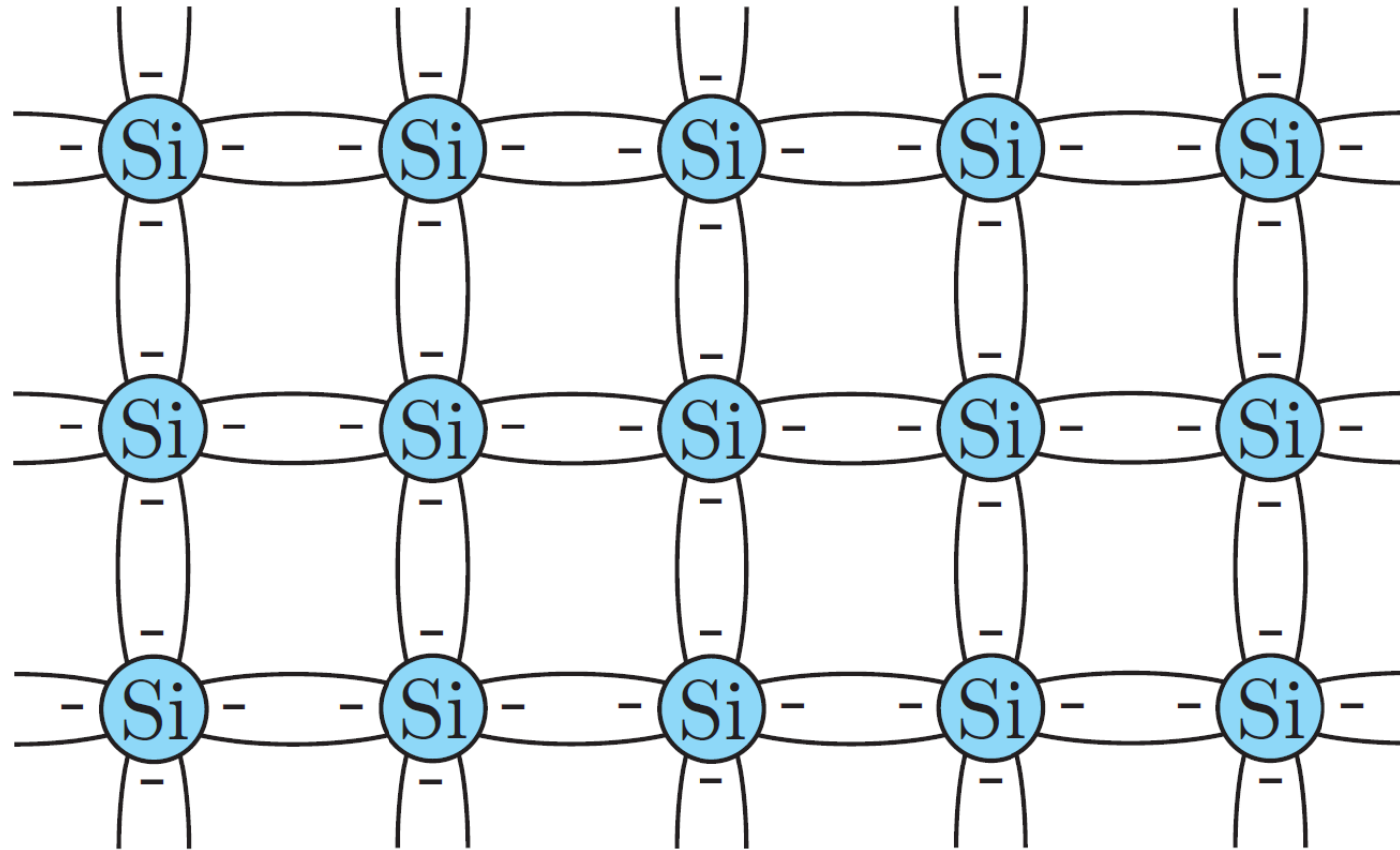
Lecture 3b

Semiconductors

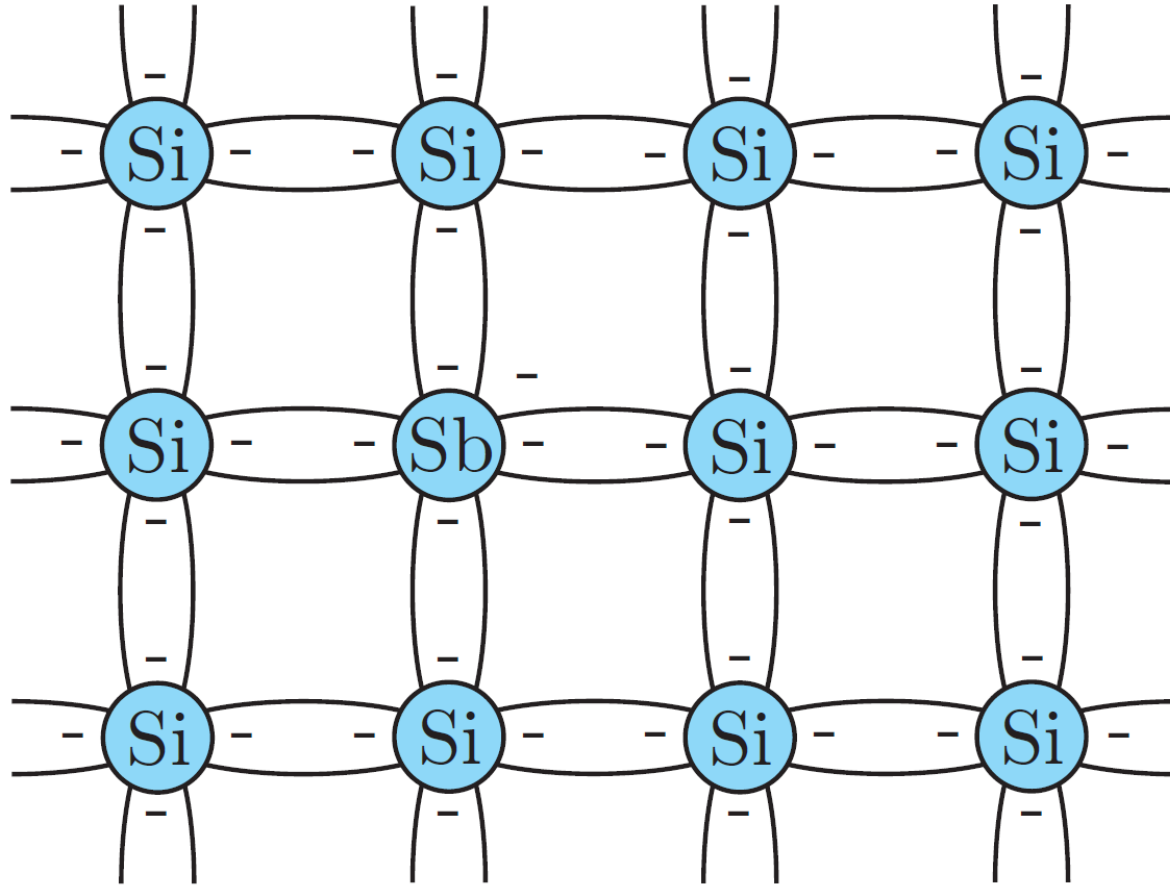
Semiconductors

- Si
- Ge
- GaAs

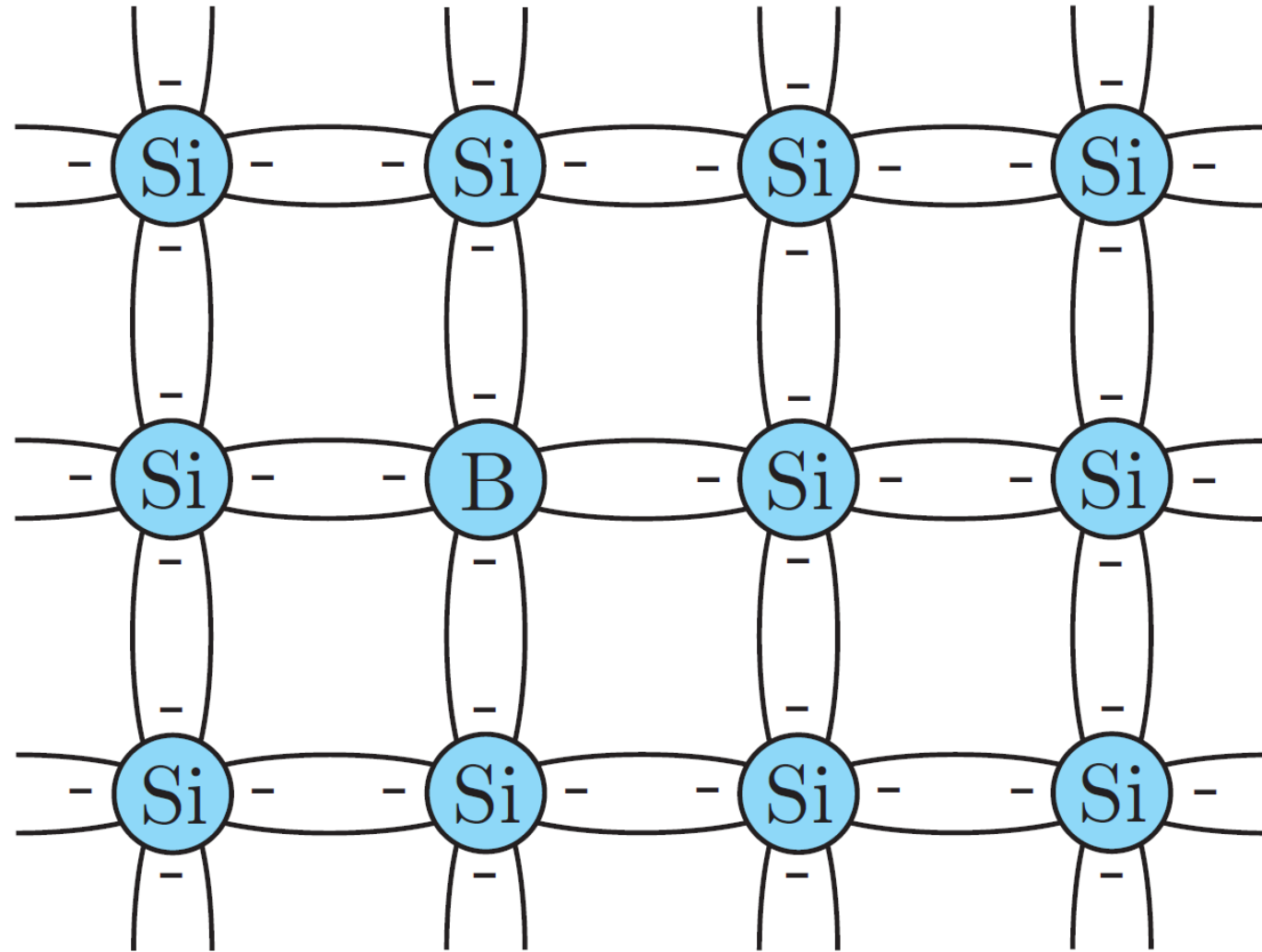
Crystal structure of silicon



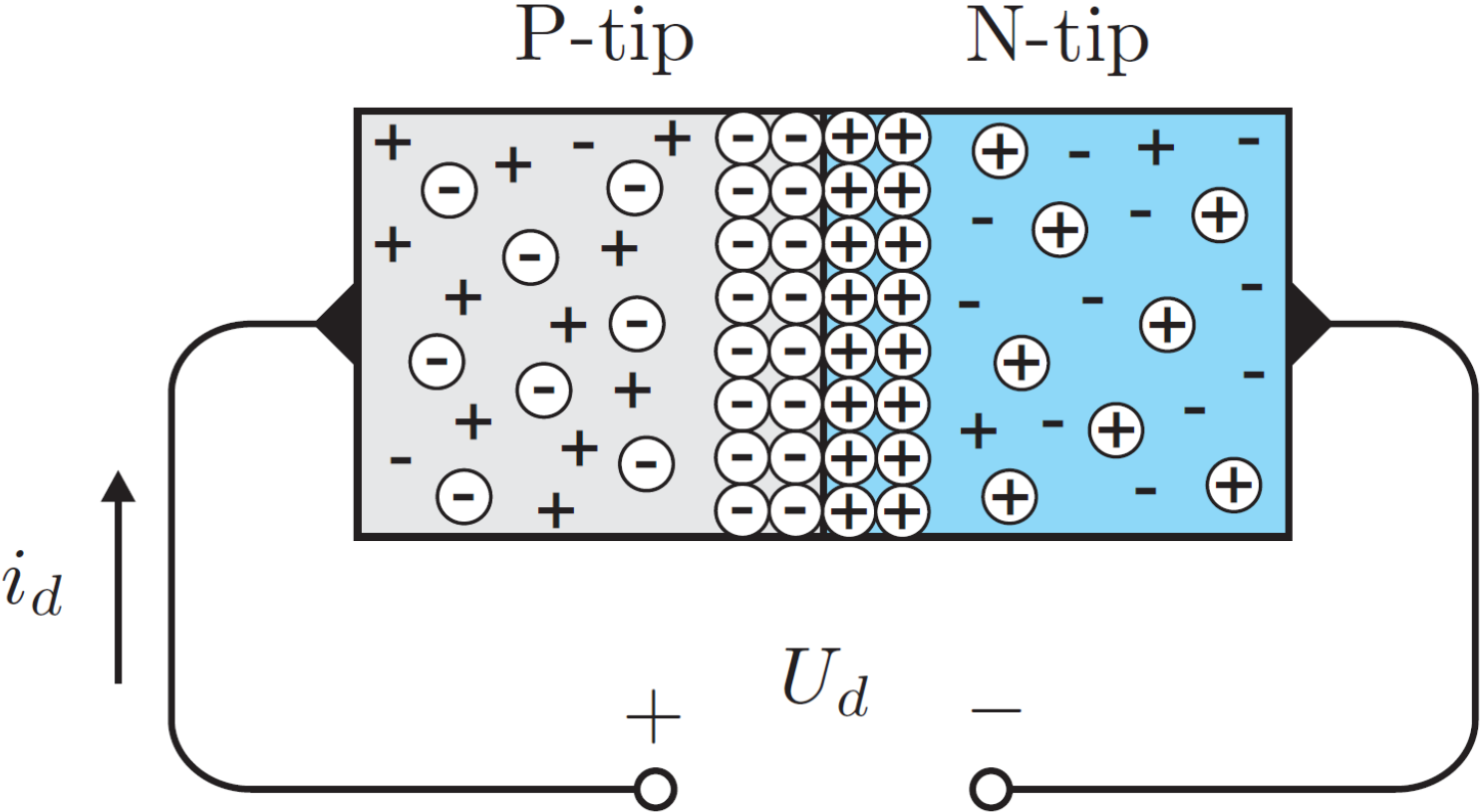
N-type semiconductor



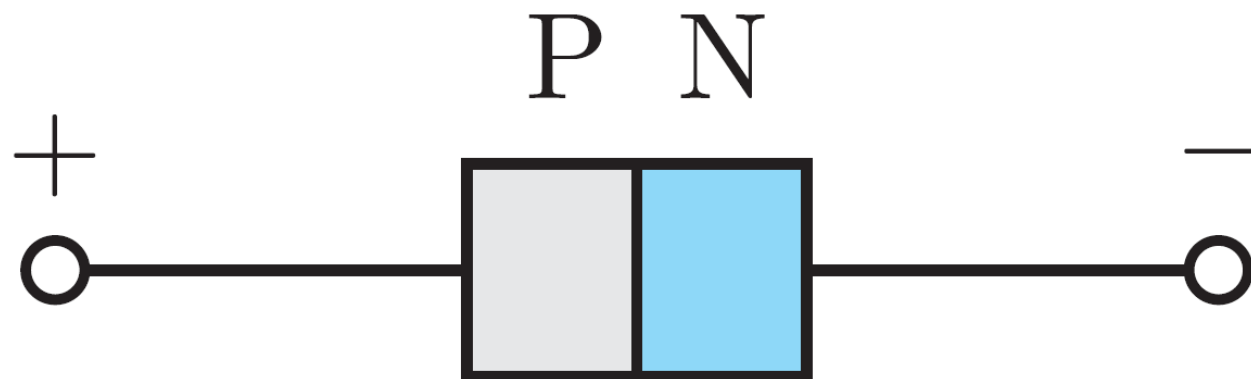
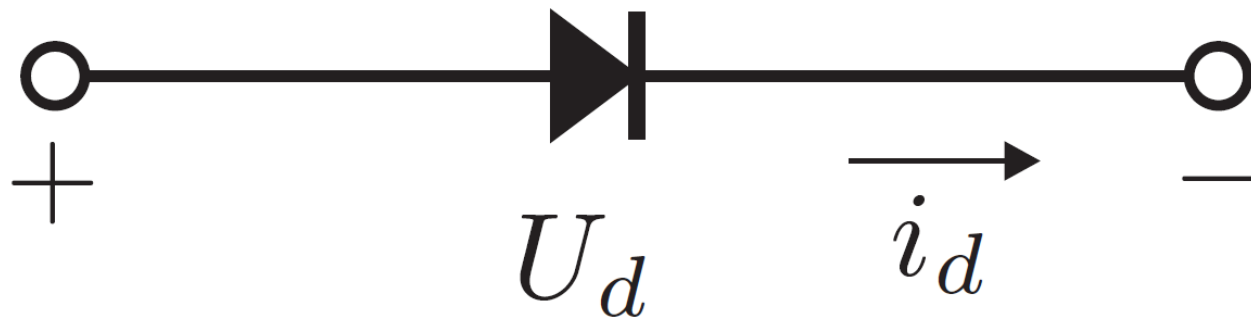
P-type semiconductor



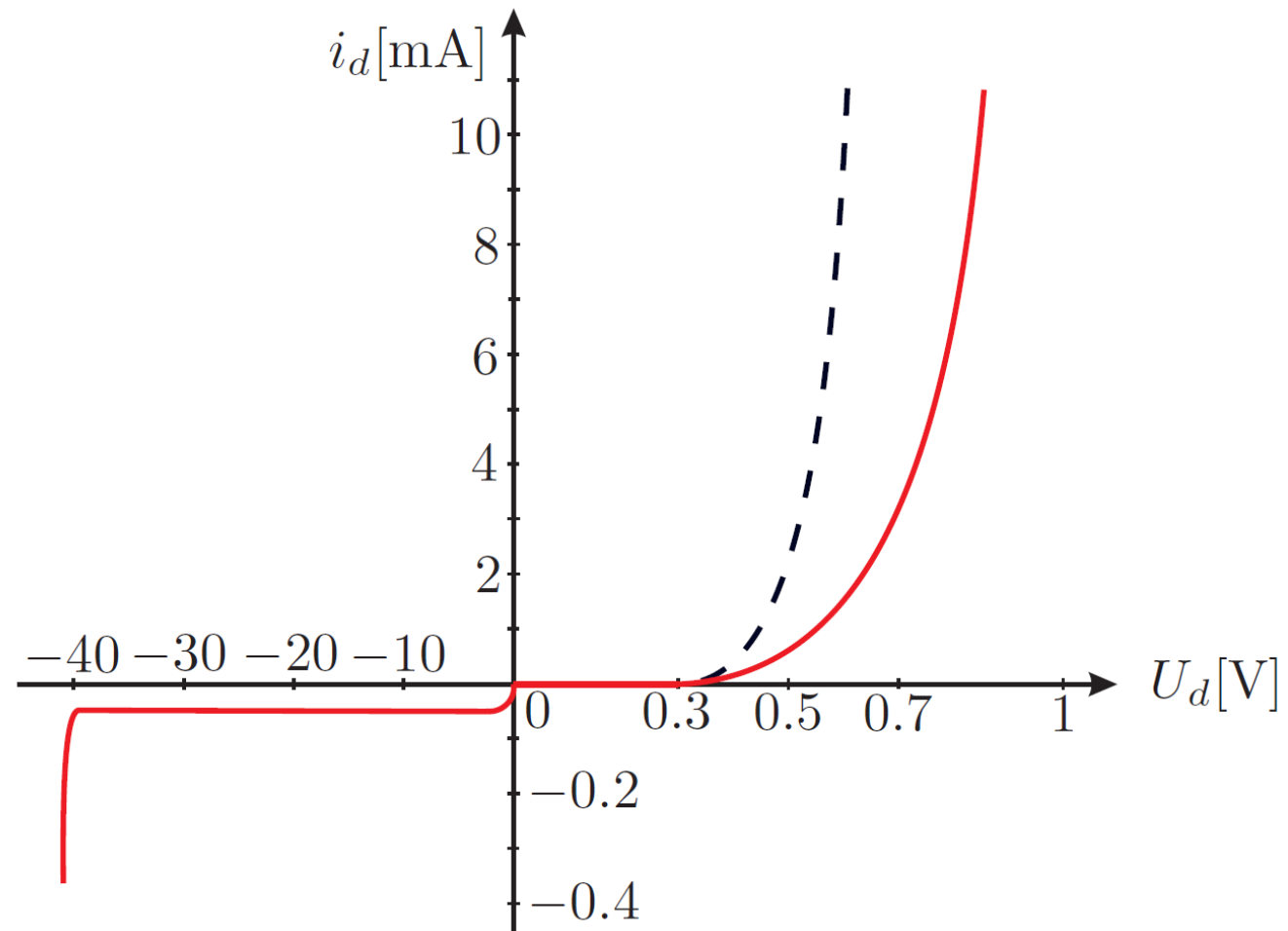
Diode



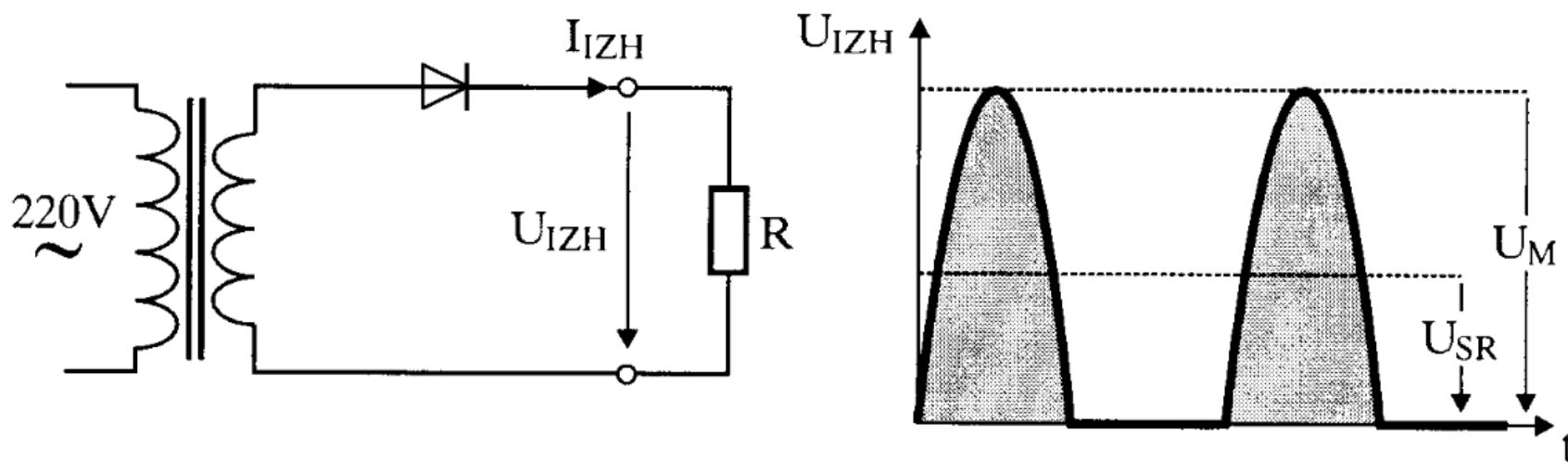
Diode (symbol)



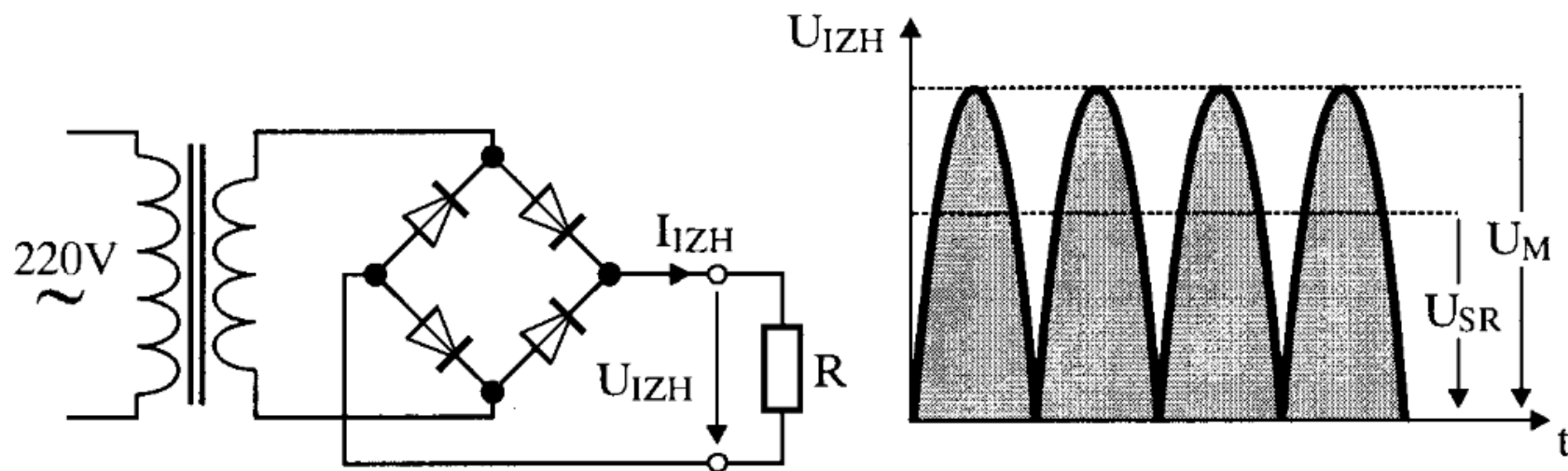
Diode characteristic



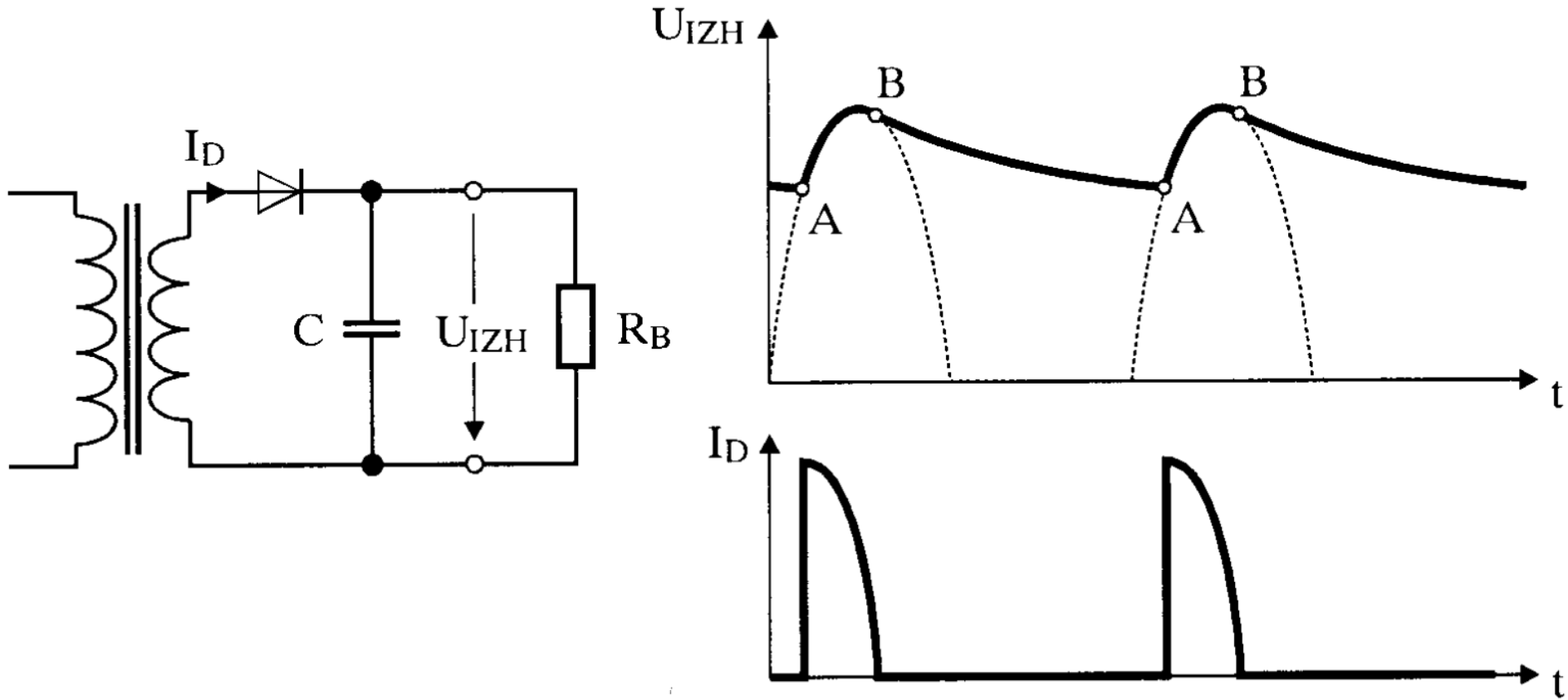
Half-wave rectifier



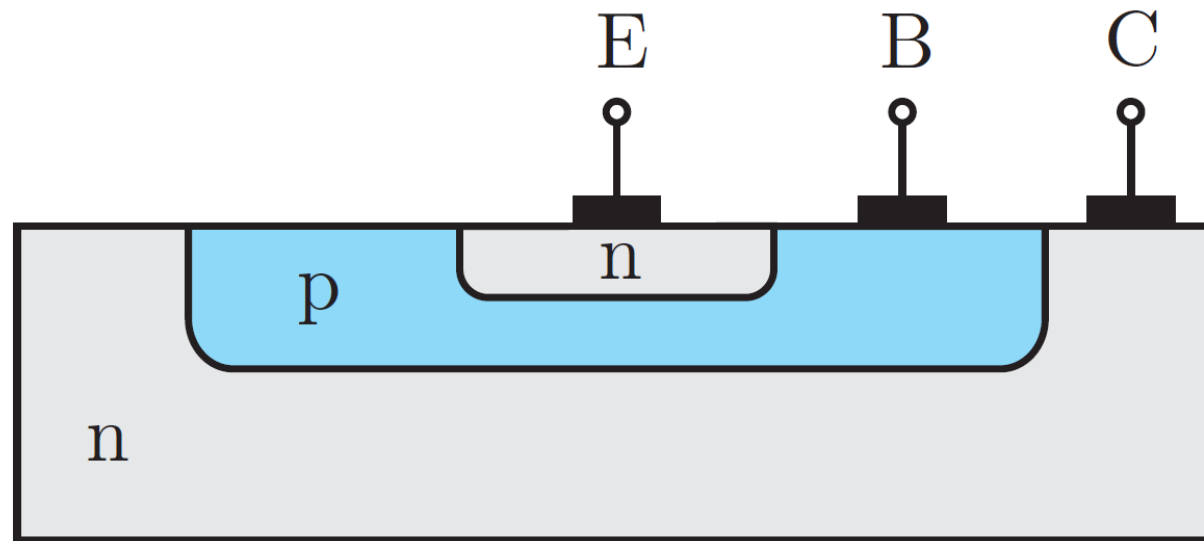
Full-wave rectifier



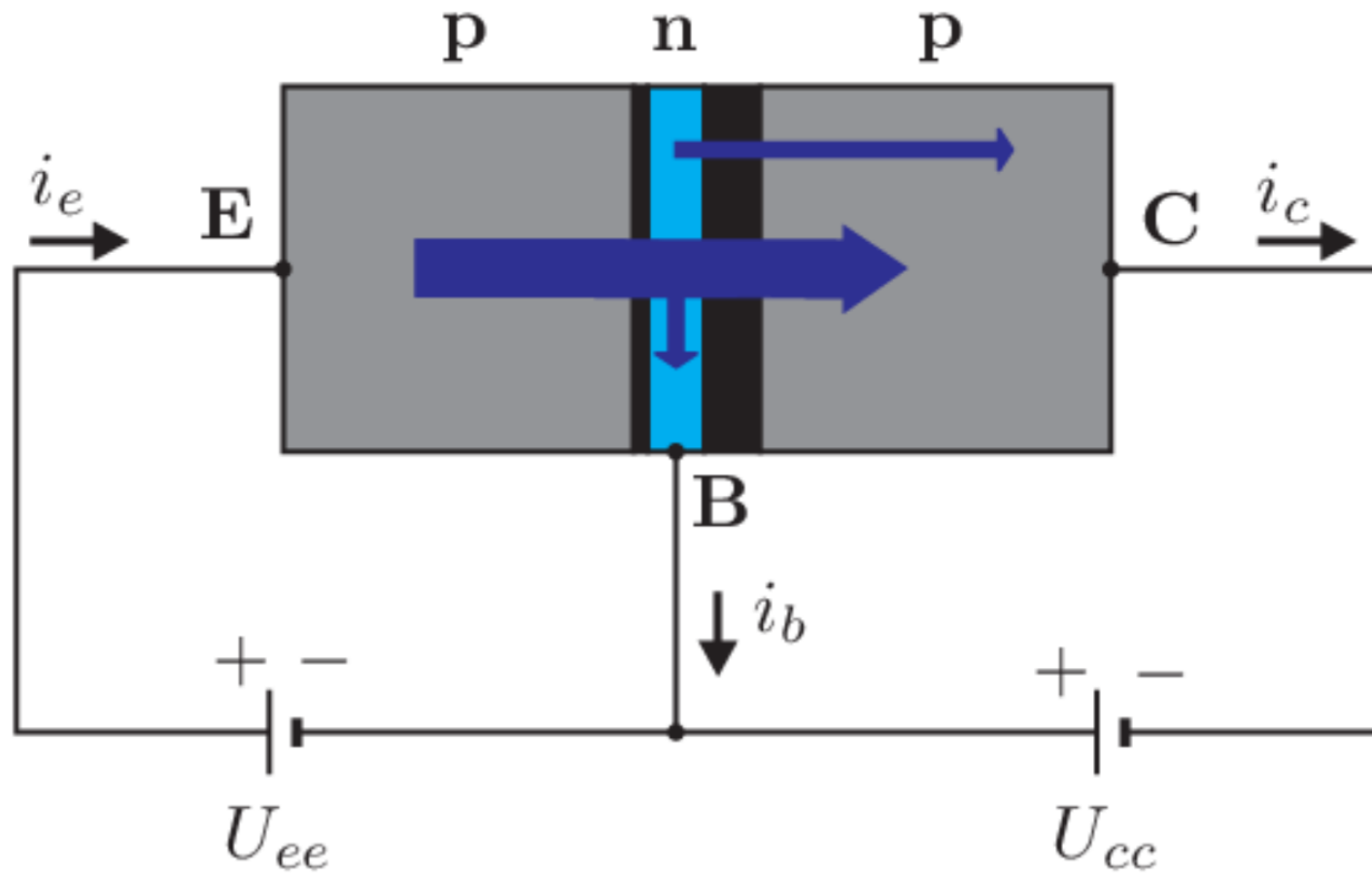
Voltage smoothing with a capacitor



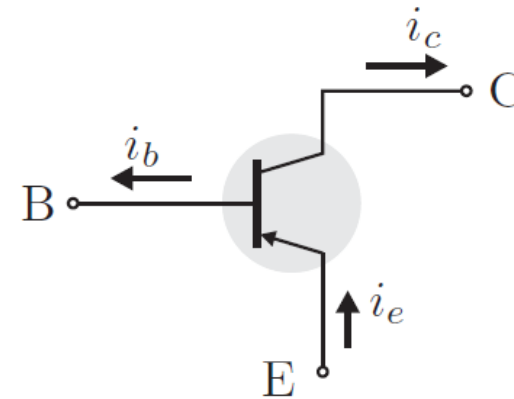
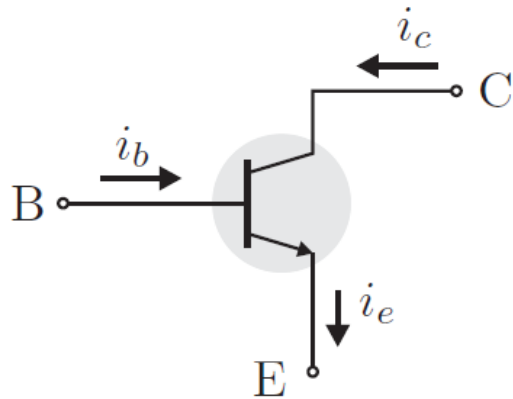
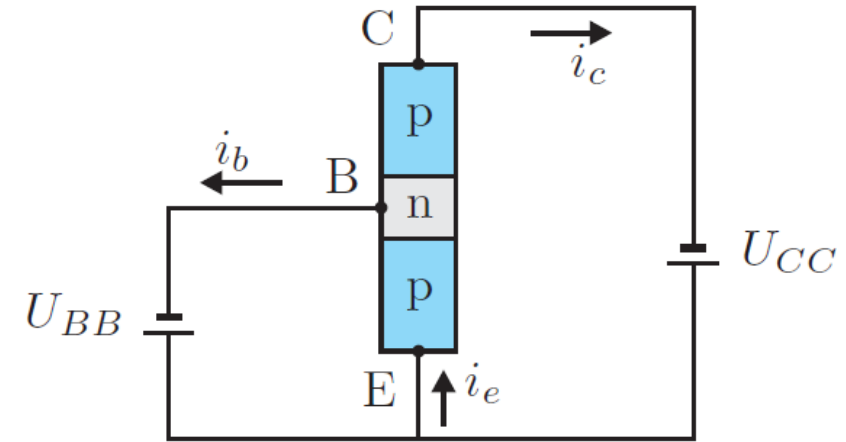
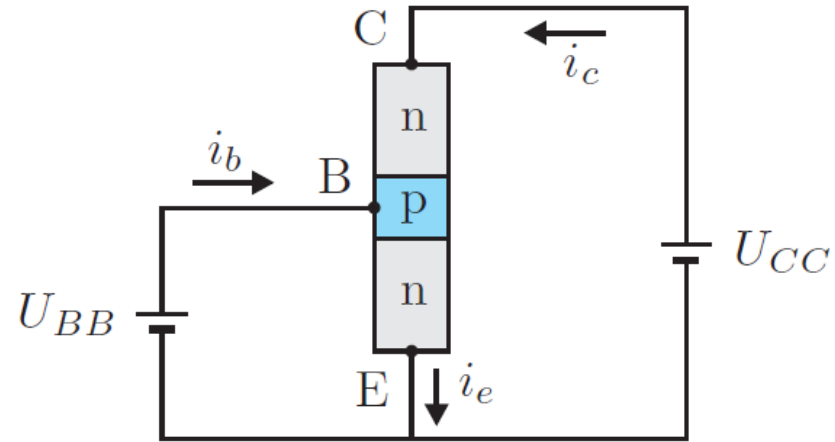
Bipolar transistor (BJT)



Principle of operation

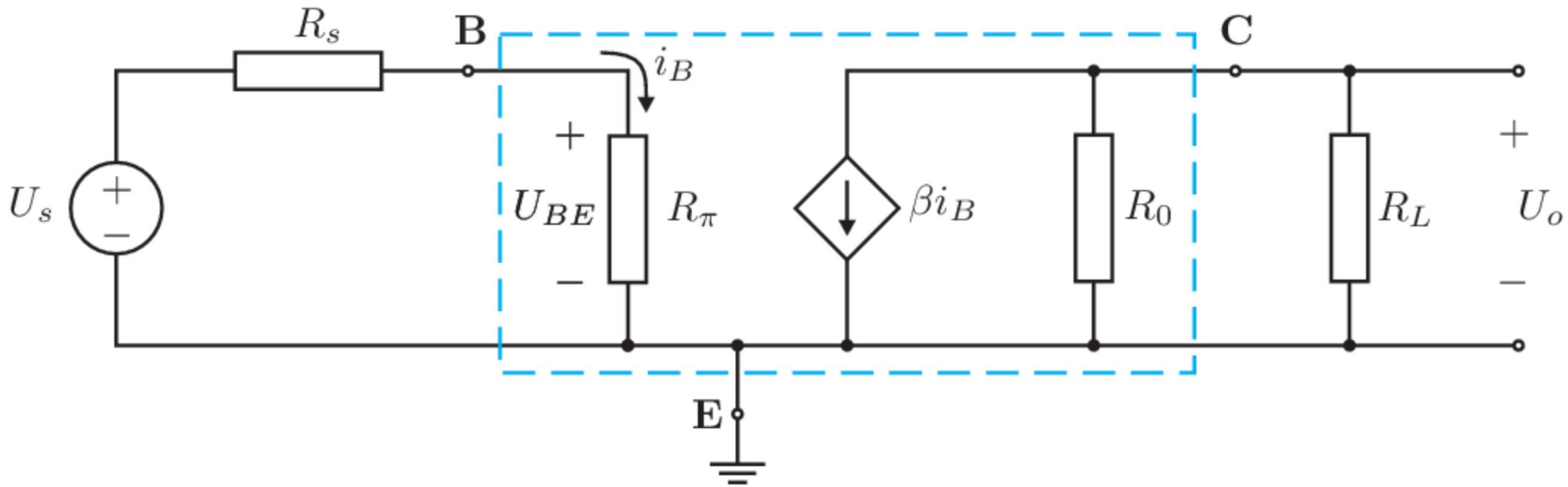


NPN and PNP orientation



$$i_e = i_b + i_c \quad ; \quad i_c = \beta i_b$$

A simplified model

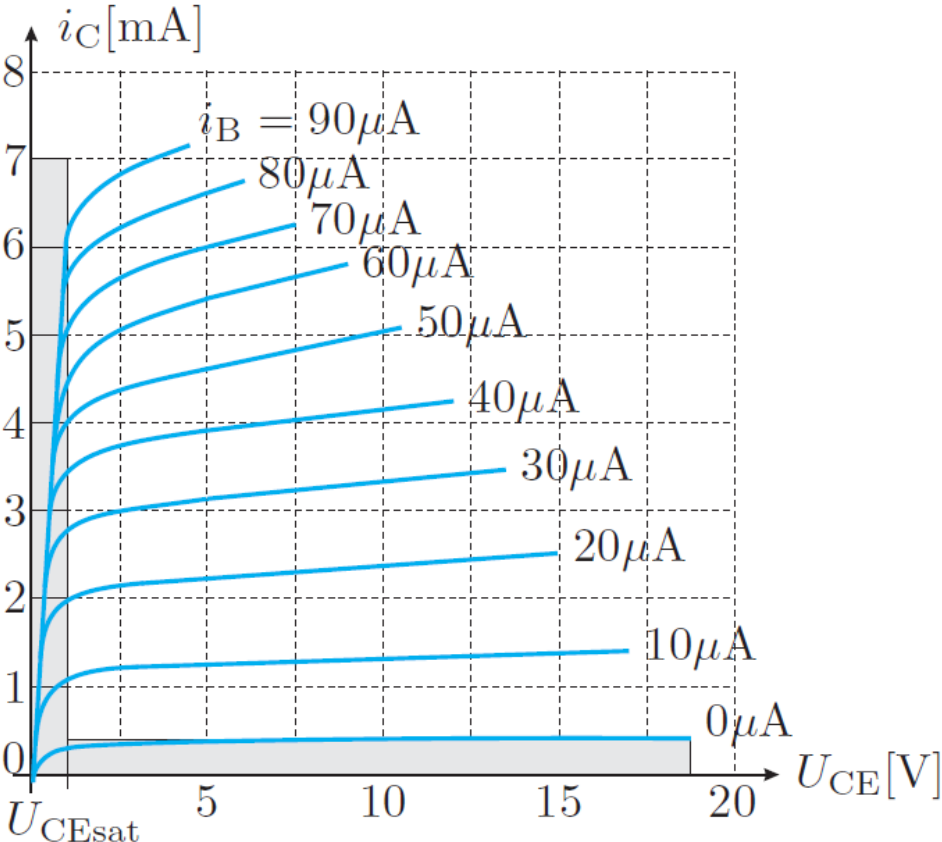
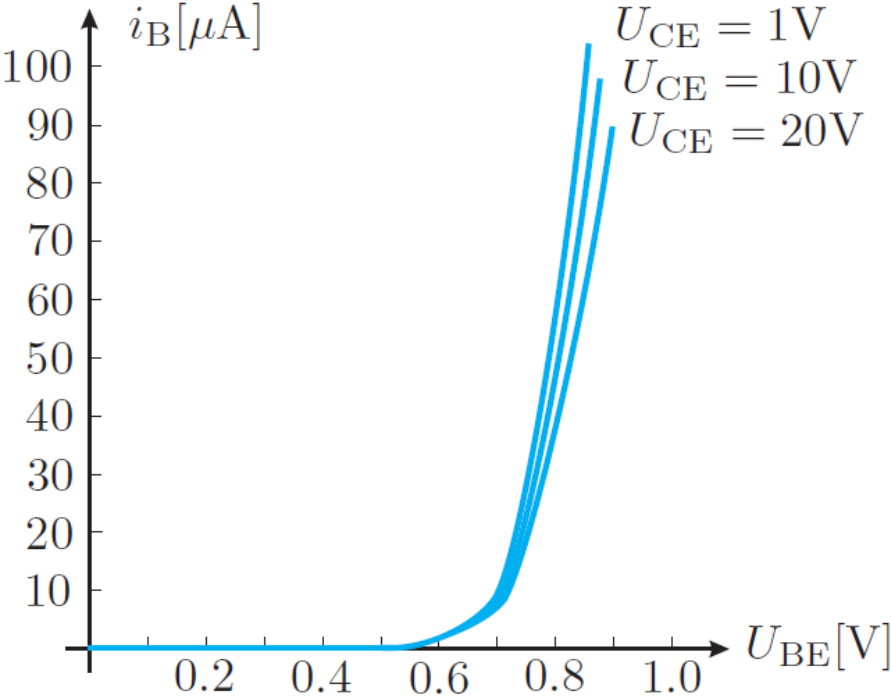


Example 1

- The transistor has a collector current of $i_c=10$ mA and a base current of $i_b=40$ μ A. What is the current gain of the transistor?

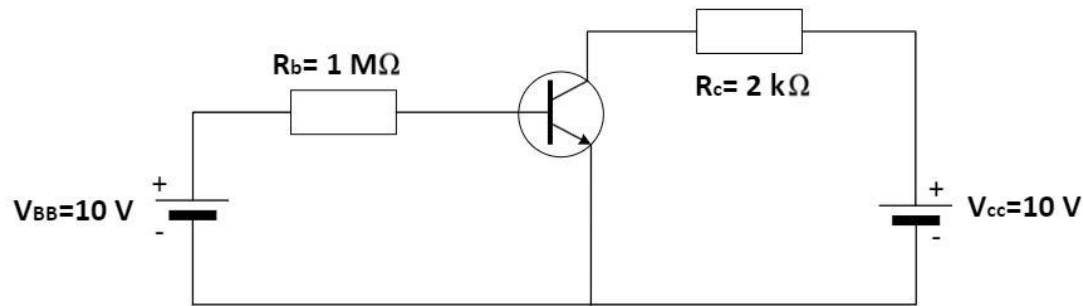
$$\beta = \frac{i_c}{i_b} = \frac{10 \text{ mA}}{40 \text{ } \mu\text{A}} = 250$$

BJT characteristic

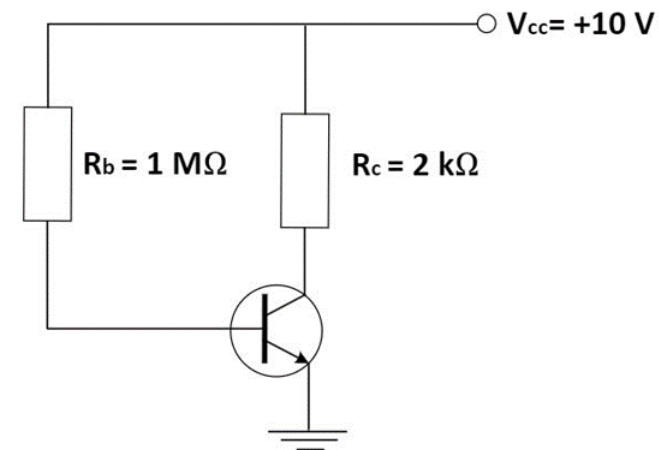


Example 2

The transistor in the figure has a current gain of $\beta=300$. Calculate i_b , i_c and P_c .



The schematic is the same as if we drew:



Example 2 (continuing)

- The base current is:

$$i_b = \frac{V_{BB} - V_{CC}}{R_b} = \frac{10 \text{ V} - 0,7 \text{ V}}{1 \text{ M}\Omega} = 9,3 \mu\text{A}$$

- The collector current is:

$$i_c = \beta \cdot i_b = 300 \cdot 9,3 \mu\text{A} = 2,79 \text{ mA}$$

- The voltage between collector and emitter is:

$$V_{CE} = V_{CC} - R_C \cdot i_C = 10 \text{ V} - 2 \text{ k}\Omega \cdot 2,79 \text{ mA} = 4,42 \text{ V}$$

- Power on the transistor (heating):

$$P_C = V_{CE} \cdot i_C = 4,42 \text{ V} \cdot 2,79 \text{ mA} = 12,3 \text{ mW}$$

Example 3

- The 2N3904 transistor operates at $V_{CE} = 10\text{ V}$ and $i_C = 20\text{ mA}$. Does it work in the safe area if the maximum power is 625 mW and "derating" is 5mW/°C? Do the calculation at 25°C and at 100°C.

$$P_D = V_{CE} \cdot i_C = 10\text{ V} \cdot 20\text{ mA} = 200\text{ mW}$$

a.) At 25°C the power is below 625 mW.

b.) At 100°C the following applies:

$$\Delta T = 100^\circ\text{C} - 25^\circ\text{C} = 75^\circ\text{C}$$

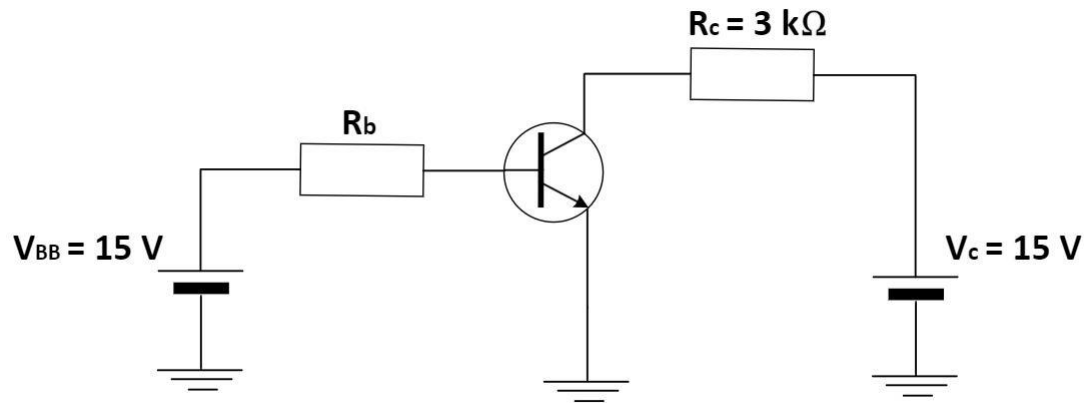
$$\Delta P = \frac{5\text{mW}}{^\circ\text{C}} \cdot 75^\circ\text{C} = 375\text{ mW}$$

$$P_{Dmax} = 625\text{ mW} - 375\text{ mW} = 250\text{ mW}$$

In both cases, therefore, operation is possible. A safety factor of 2 is usually taken into account. In this case, it would already be problematic at 100°C.

Example 4

- What should the resistance R_b be, if we want the resistance $R_c = 3 \text{ k}\Omega$ to have the power of 27 mW?



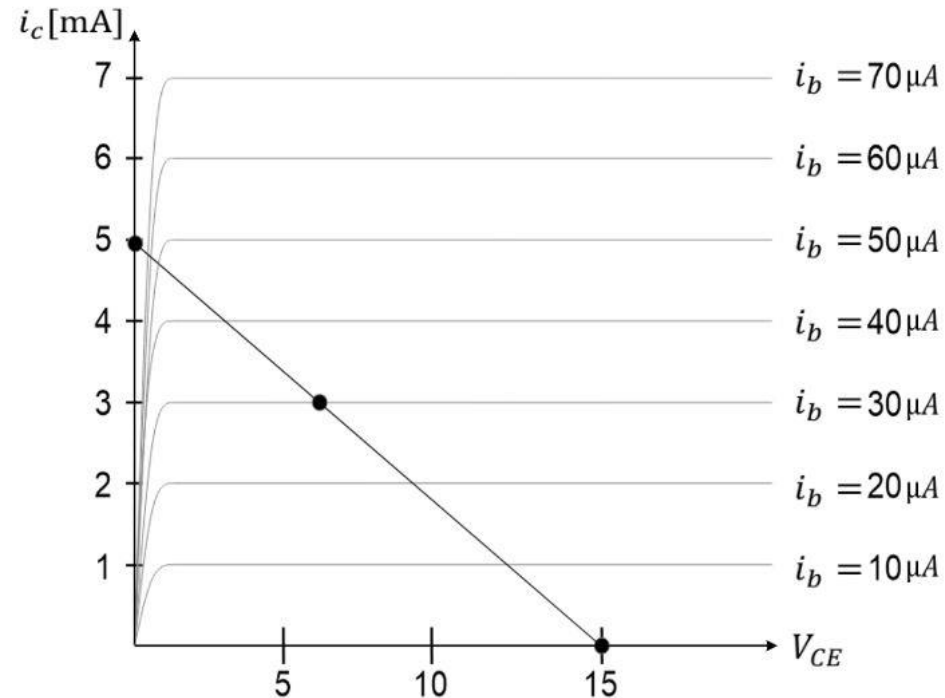
$$P_c = R_c \cdot i_c^2 \Rightarrow i_c = \sqrt{\frac{P_c}{R_c}} = 3 \text{ mA}$$

Example 4 (continuing)

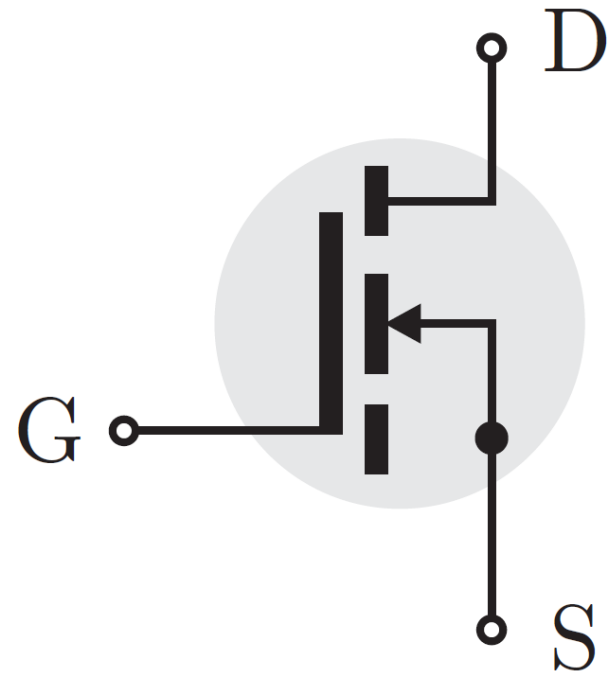
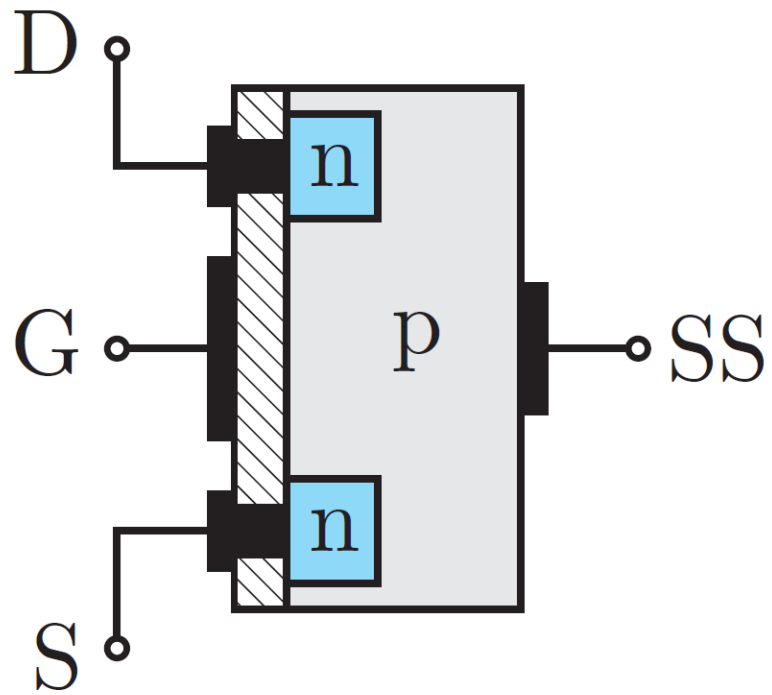
- $$i_c = \frac{U_{CC}}{R_C} - \frac{U_{CE}}{R_C}$$

- From the graph: $i_b = 30 \mu A$

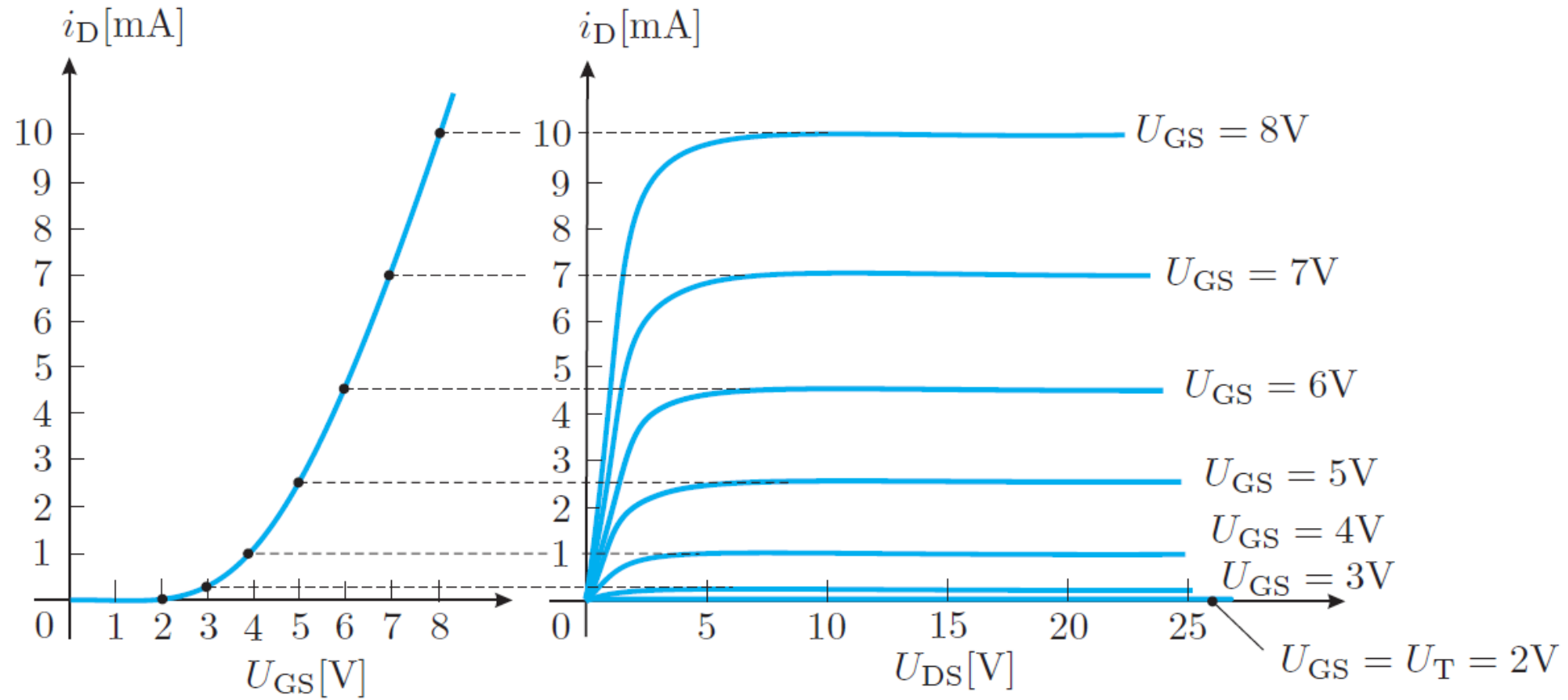
- Resistance $R_b = \frac{V_{bb}}{i_b} = \frac{15 V}{30 \mu A} = 500 k\Omega$



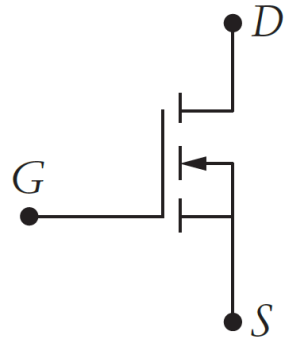
Field-effect transistor (FET)



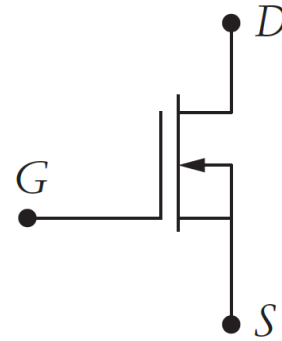
FET characteristic



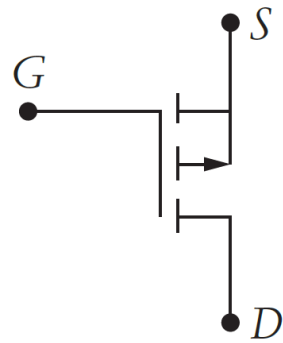
MOSFET types



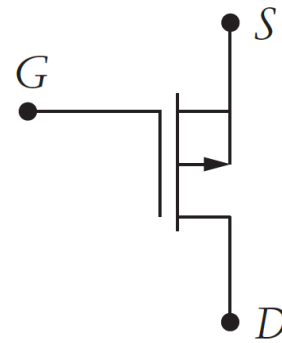
NMOS, Enhanced mode



NMOS, Depletion mode

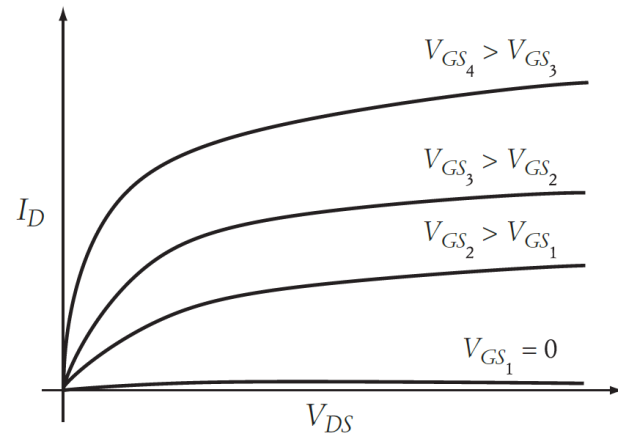


PMOS, Enhanced mode

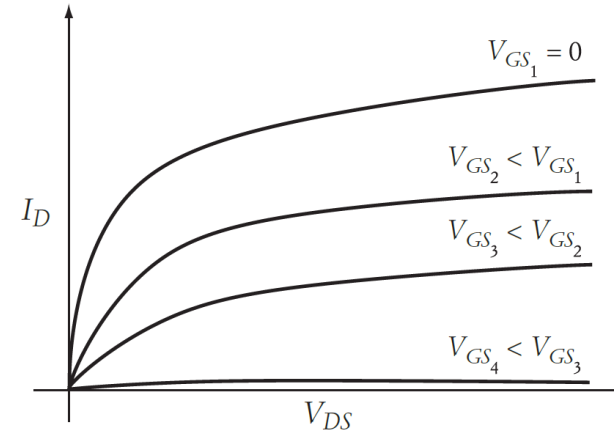


PMOS, Depletion mode

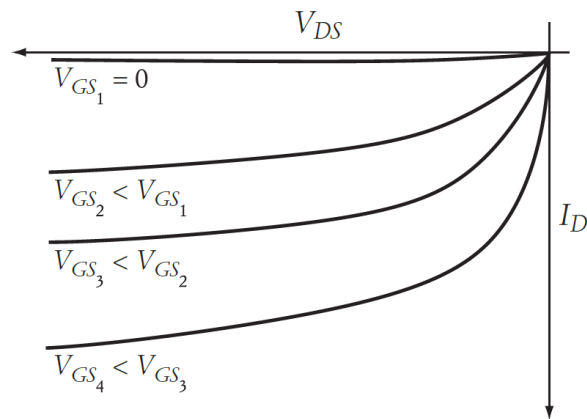
MOSFET characteristics



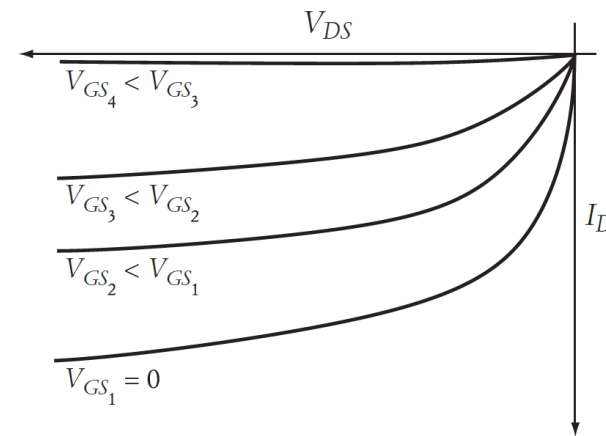
NMOS, Enhanced mode



NMOS, Depletion mode

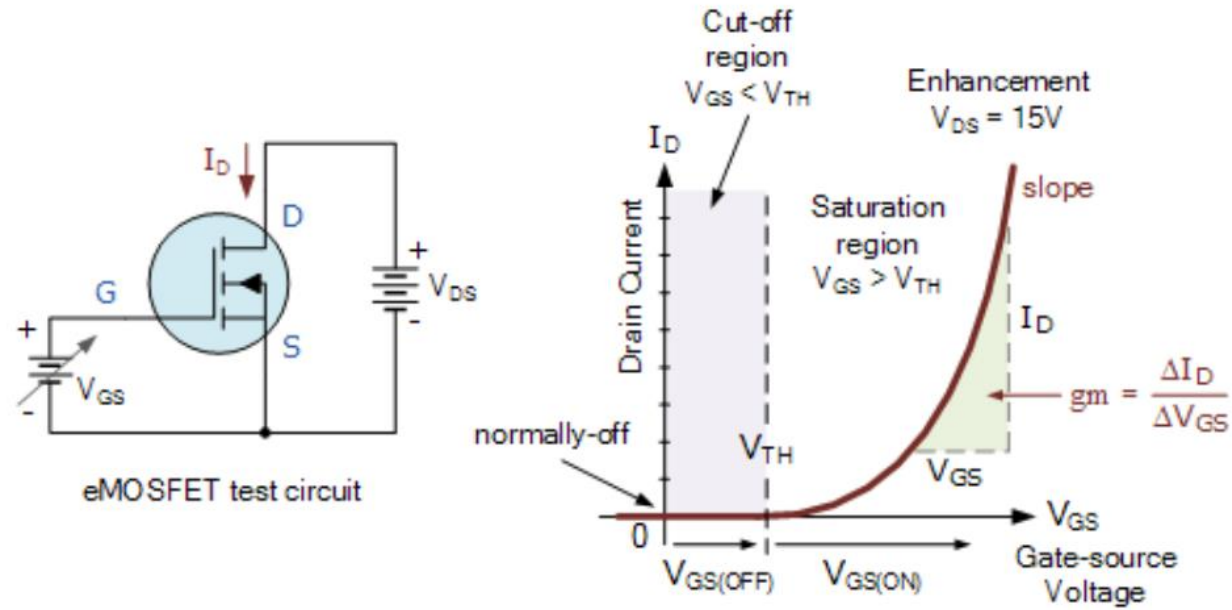


PMOS, Enhanced mode



PMOS, Depletion mode

N-channel eMOSFET I-V characteristics



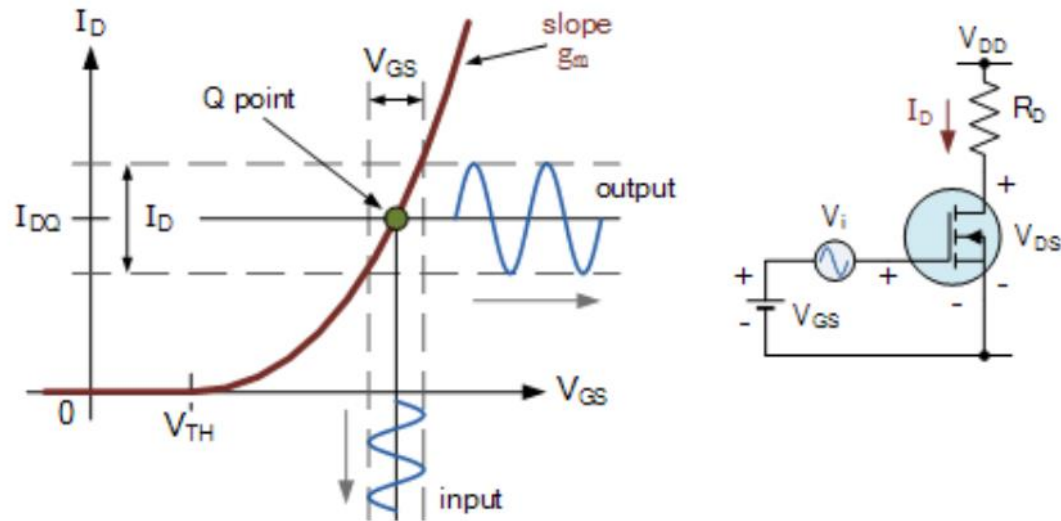
Transfer conductance (gm)

$$gm = \frac{\Delta I_D}{\Delta V_{GS}}$$

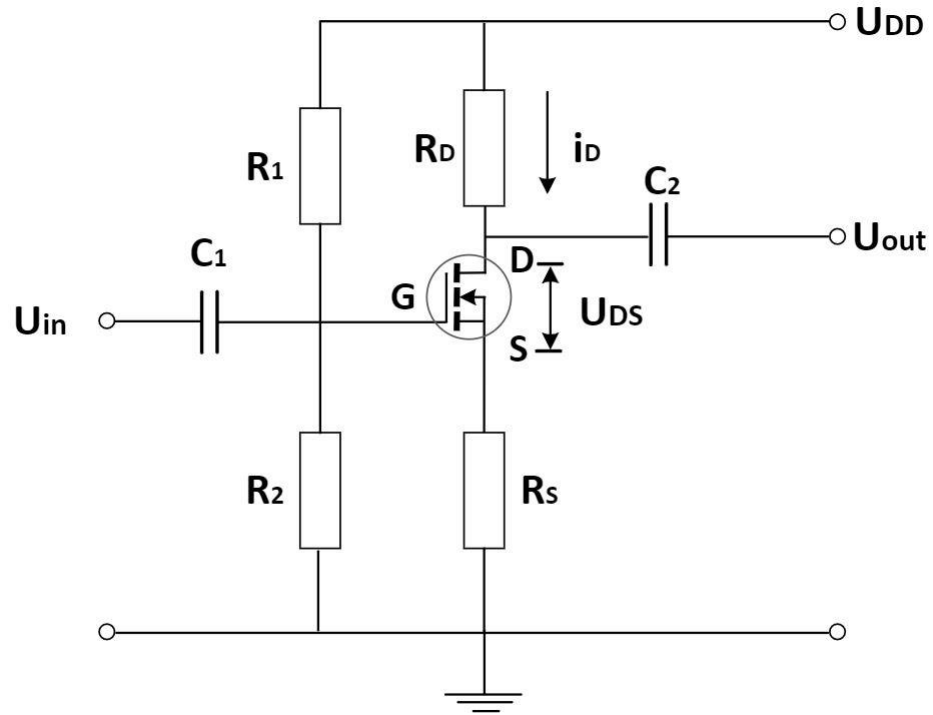
eMOSFET drain current:

$$I_D = k(V_{GS} - V_{TH})^2$$

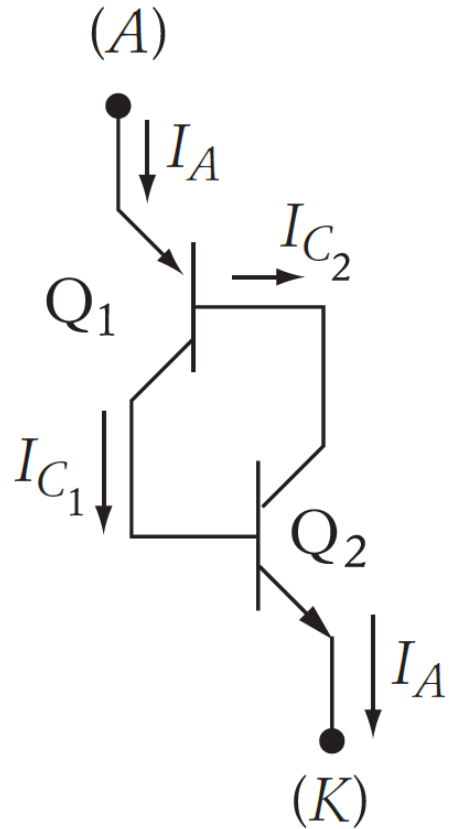
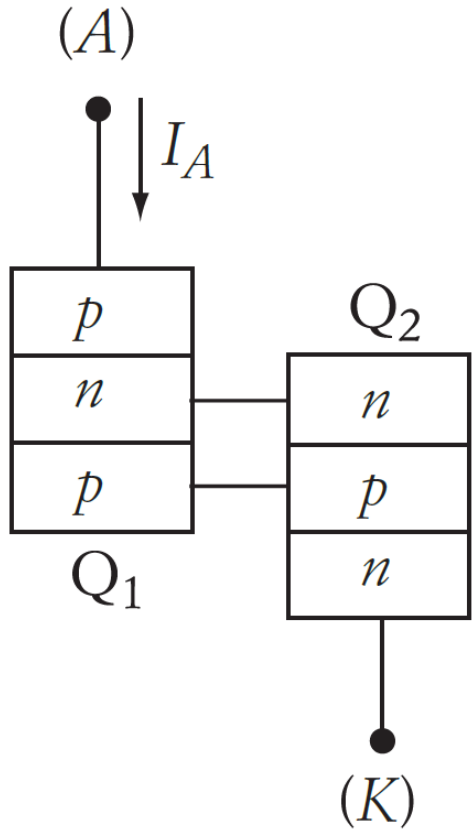
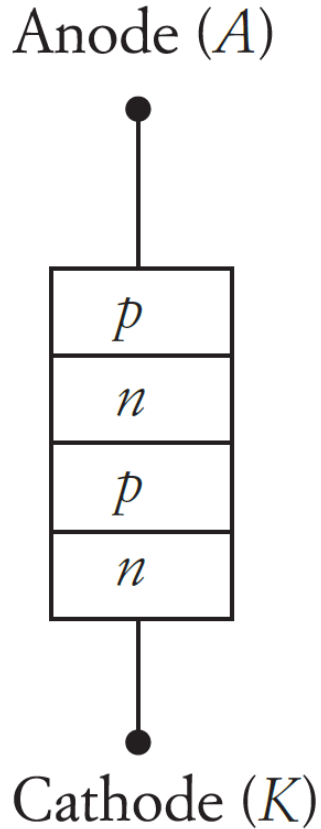
eMOSFET DC bias point



Amplifier based on MOSFET with conduction coefficient



Thyristor



Equations

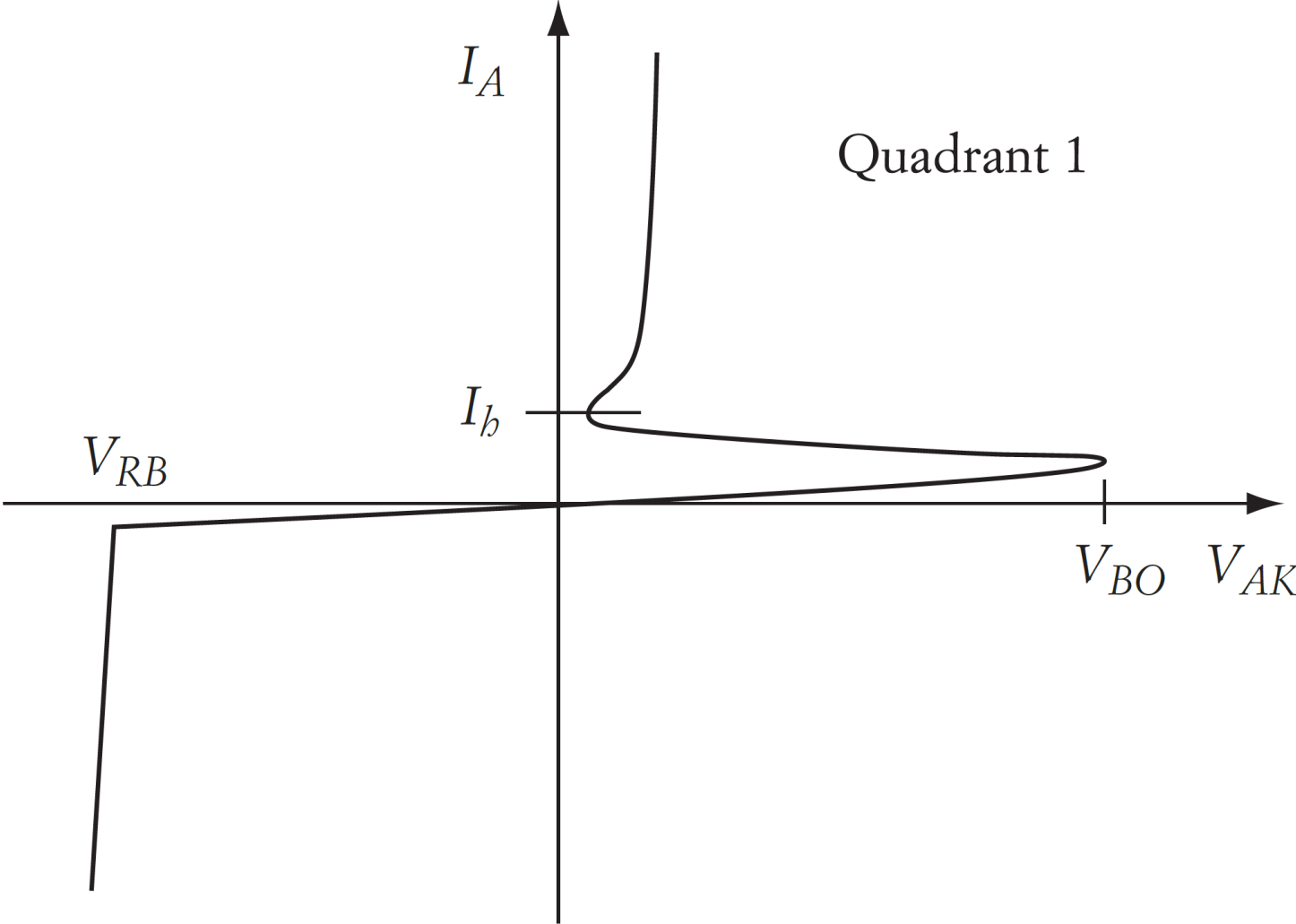
$$I_{C_1} = \alpha_1 I_A + I_{CBO_1}$$

$$I_{C_2} = \alpha_2 I_A - I_{CBO_2}$$

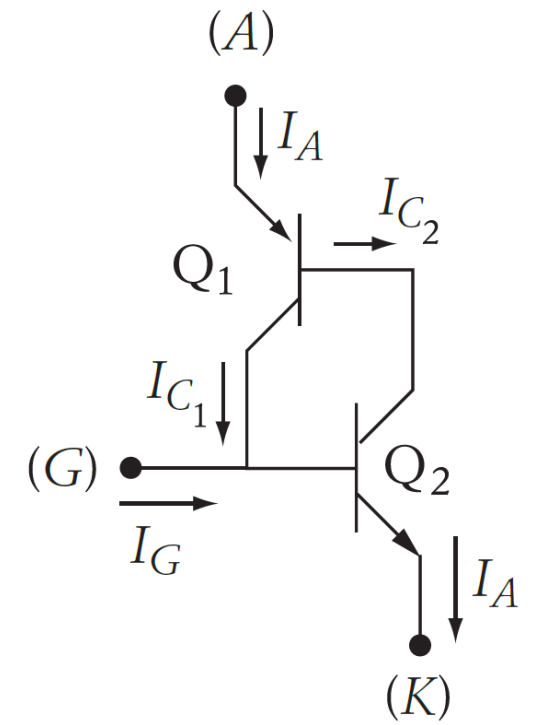
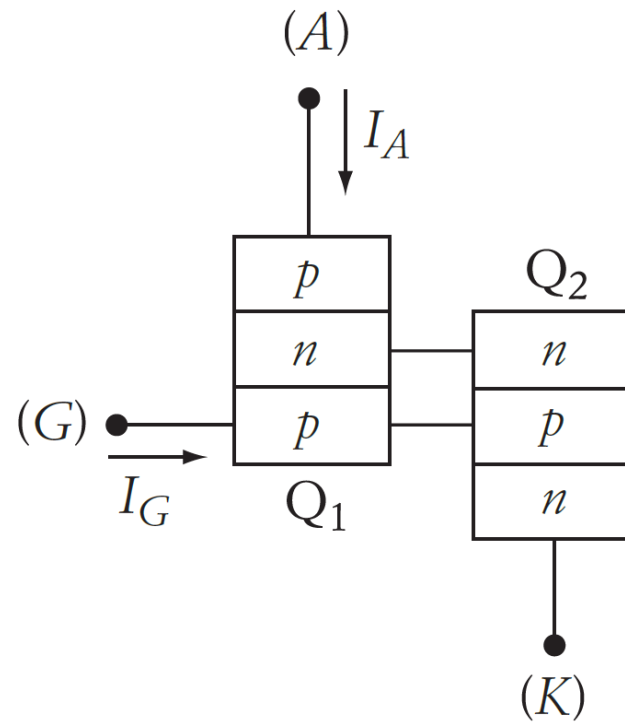
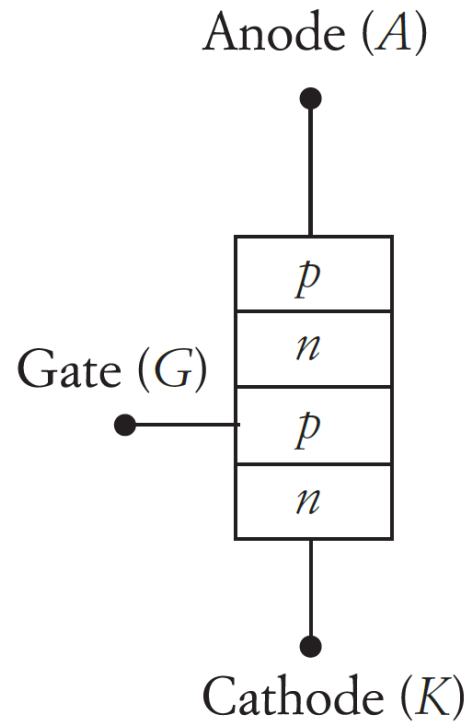
$$I_A = I_{C_1} + I_{C_2}$$

$$I_A = \frac{I_{CBO_1} - I_{CBO_2}}{1 - (\alpha_1 + \alpha_2)}$$

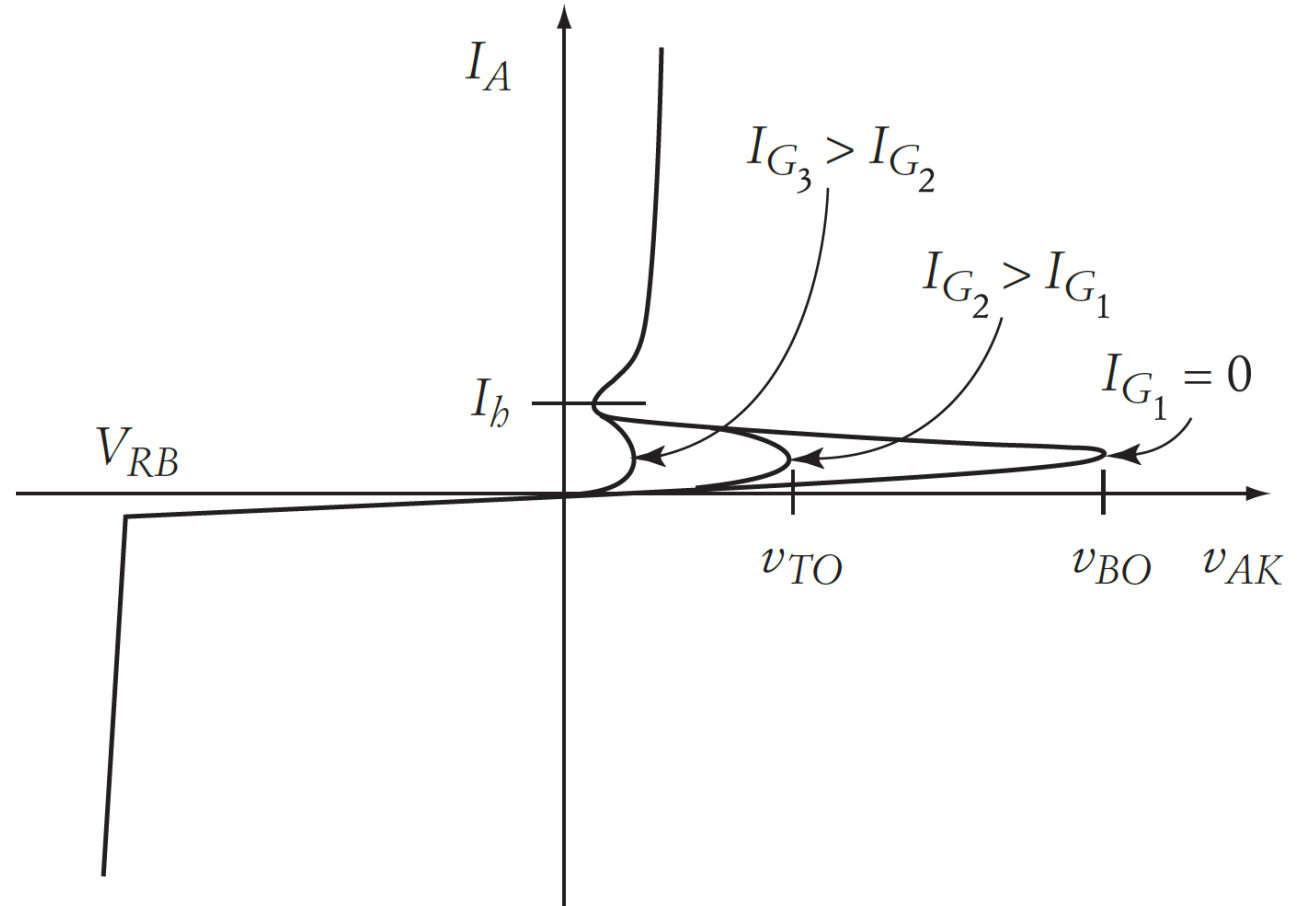
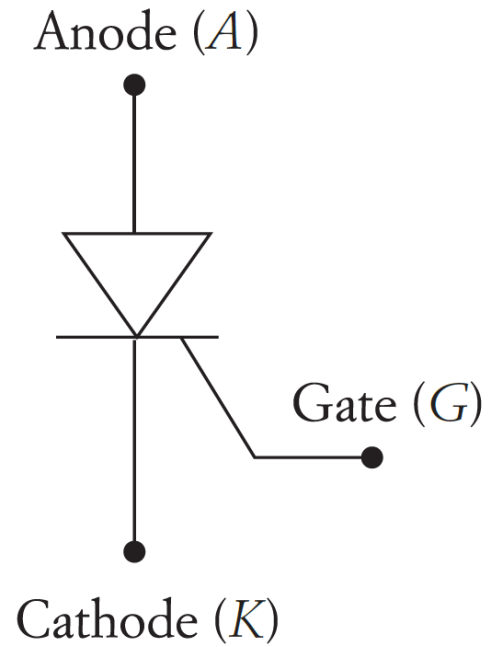
Thyristor characteristic



SCR



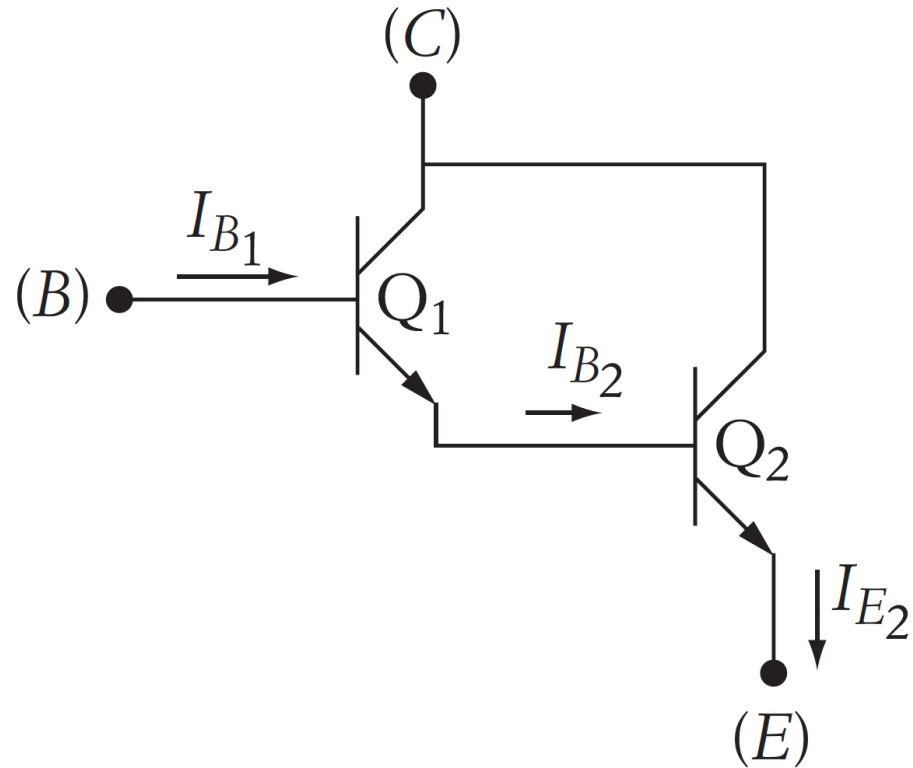
SCR characteristic



SCR features

- Cheaper production than FET
- They are triggered by a pulse and not by permanent current
- In AC circuits, they are self-extinguishing
- They allow much higher currents and voltages than transistors

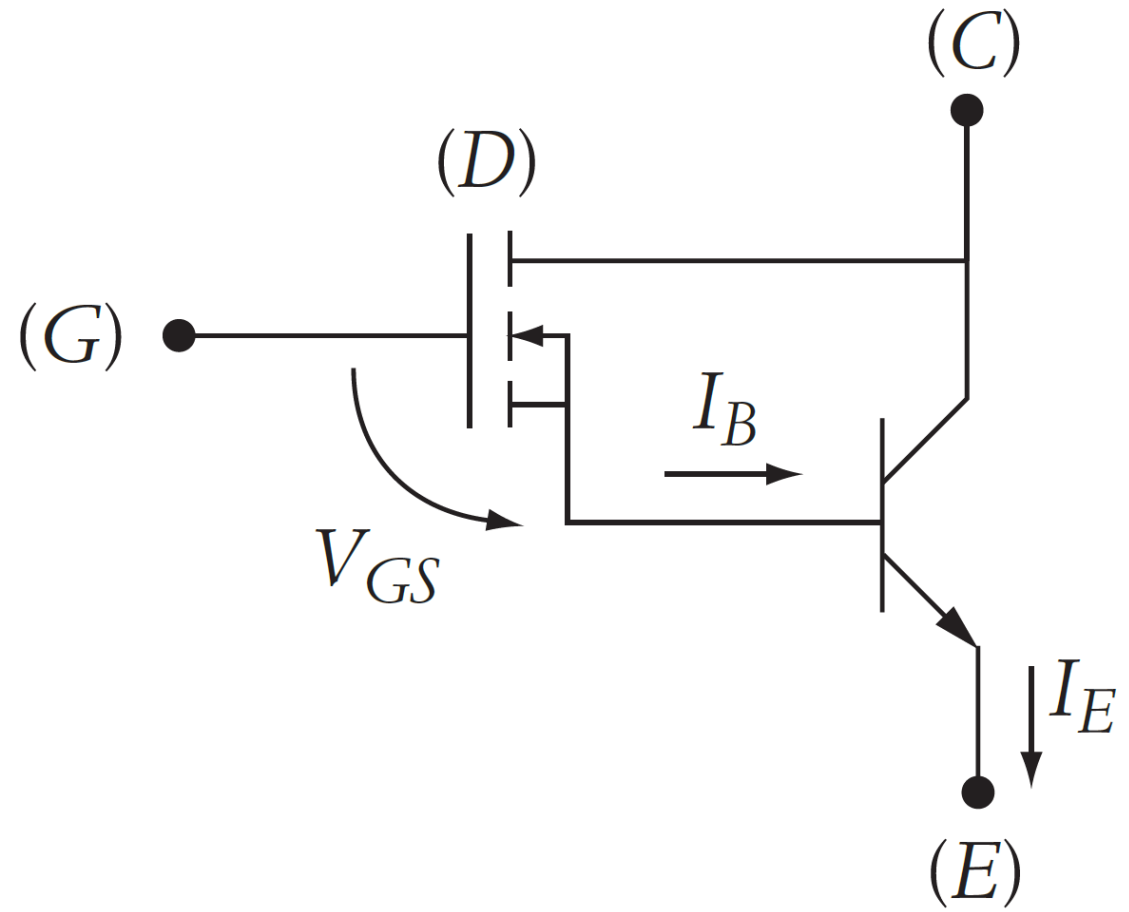
Darlington transistor



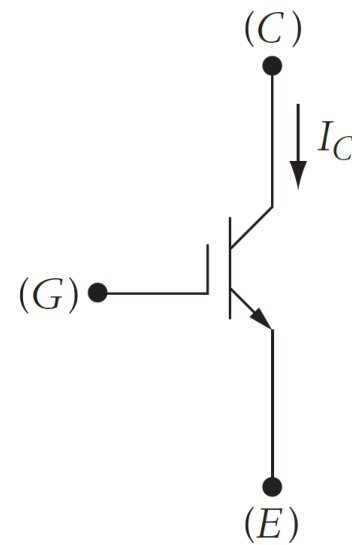
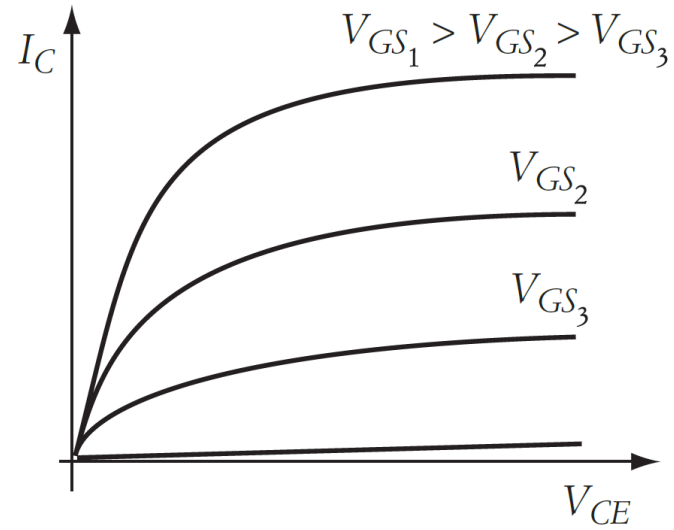
$$I_{E_2} = (1 + \beta_2)I_{B_2} = (1 + \beta_2)(1 + \beta_1)I_{B_1}$$

$$\frac{I_{E_2}}{I_{B_1}} = (1 + \beta_1)(1 + \beta_2)$$

IGBT



IGBT characteristic



Limitations

- Steady-state circuit ratings
- Junction temperature
- Surge current
- Switching time
- Critical rate of rise of current (or maximum di/dt)
- Critical rate of rise of voltage (or maximum dv/dt).